

EMI NOISE FILTERING AND POWER MAGNETIC Solutions





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An Overview of Laird Performance Materials

We enable high-performance electronics. Laird creates advanced solutions for electronic components and systems. World-leading technology brands rely on Laird for improved protection, higher performance and reliability, custom structural designs and faster time-to-market. Steward was acquired by Laird in 2006, Laird Steward is now part of Laird. Our 4,000 employees are dedicated to your success.

We solve design issues through innovative products such as EMI suppression or absorption materials, thermal interface materials, structural and precision metals, **Laird™ Steward™ magnetic ceramic products** and multi-functional solutions. This latter product family solves multiple EMI, thermal and structural design issues simultaneously using a single process solution.

Laird engages a world-class group of top distributors and manufacturer representative organizations to extend our reach. They help ensure that every customer or potential customer of Laird's products in every region of the globe receives prompt, engineer-to-engineer attention along with the guidance, design and manufacturing excellence and exceptional customer service required to succeed.

The company designs and manufactures standardized, customized, and performance-critical products for applications in many industries including:

Telecommunications and Datacom Information technology Consumer Electronics including Gaming Automotive Medical Aerospace and Defense Wearable devices Industrial and Instrumentation

Laird offers customers a vast array of unique product solutions, our dedication to research and development, and a seamless network of manufacturing and customer support facilities across the globe. Visit Laird at www.laird.com

High Frequency, Power and General Filtering or Transmitting Using Laird[™] Steward[™] Ferrite Products

Laird offers an extensive product lineup of ferrite cores, EMI noise filtering and wireless power transmitting components for EMI management in signal interfaces, clock and power lines. Our ferrite-based product families preserve signal integrity by removing or filtering the 'EMI noises' generated by active components such as microprocessors, microcontrollers and System-on-Chip (SoC), couplings from DC power lines, broadcasting from the ambient environment, and other sources.

Your Best Choice!

No matter whether your EMI/EMC problem is common or unique – Laird solutions will always be your best choice for every design! As an industry-leading signal integrity and power magnetic products and solutions provider, we provide a broad range of standardized and customized products, including Ferrite Toroid and Balun Cores, Cable Cores, Chip Beads and Inductors, SMT Bead Assemblies, Common Mode Chokes, SMT Power Inductors and Wireless Charging Coil Assembly.

We also design, manufacture and sell many unique high-performance products which support high DC current rating with minimal performance degradation under bias, low DCR, and a small footprint that is suitable for power supply and DC/DC conversion designs in a variety of mobile computing and other devices.



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Note: Automotive grade available upon request



All parts listed in this catalog are lead free and RoHS compliant.

NOTICE

Laird products or subcomponents are not specifically designed or tested by Laird for use in any medical applications, surgical applications, medical device manufacturing, or any similar procedure or process requiring approval, testing, or certification by the United States food and drug administration or other similar Governmental entity. Applications with unusual environmental requirements such as military, medical, life- support or Life-sustaining equipment are specifically not recommended without additional testing for such application.

Page

Ferrite Cable Cores

For Round, Ribbon & Flex Cables & Wiring

Laird produces an extensive line of ferrite products for cable harness assemblies, and flexible cable assemblies. These cable core products are mainly used for inductive and EMI filtering applications and are available in three (3) different types of materials (refer below) based on operating frequency ranges.

Available in 3 different materials:

- High Frequency | HF Part Series (300 MHz 2 GHz)
- Broadband | 28 Part Series (30 MHz 1 GHz)
- Low Frequency | LF Part Series (300 KHz 30 MHz)

Split, Snap-On Cores In Plastic Cases

• 28A-, HFA-, 28S- Part Series

For retrofit and post assembly operations, Laird offer a selection of "split" cores. Similar in performance to Laird's one-piece core designs, these split ferrite cores provide excellent common and differential mode EMI suppression on round cable and wire assemblies. Black or white plastic snap-on cases provide secure closure of the split cores onto the cable.

Ferrite Plates and Disks for EMI

• MM-, MP- Part Series

Ferrite plates and disks can also be used as magnetic coupling and shielding for wireless charging applications based on magnetic induction technology. Magnetic flux is directed and concentrated from the wireless charging transmitter side to the receiver side with minimum power loss and electromagnetic field leakage.

BENEFITS TO CUSTOMER

Enable lighter and smaller designs Broad band noise suppression

Laird⁻



BENEFITS TO CUSTOMER

Easy to install with good flatness Broadband noise suppression







Ferrite Plate for Inductive Wireless Charging

MP & 33 Series

Features:

- Ferrite materials are Wireless Power Consortium (WPC) listed, recommended & certified for interoperability test
- Optimized for highest charging efficiency
- Precise dimension control and automotive grade available
- 40°C to 125°C operating temperature
- Available in wide range of size selection, custom shapes are also available

BENEFITS TO CUSTOMER

Maximize wireless charging efficiency

Reduce EMI leakage and reduce EMC cost



Materials

PROPERTY	SYMBOL	UNIT	28 MATERIAL (WPC LISTED)	33 MATERIAL
Initial Permeability	μi		650	2300
Flux Density	В	mT [Gauss]	280 [2800]	390 [3900]
@ Field Strength	Н	A/m [Oe]	800 [10]	800 [10]
Residual Field Strength	Br	mT [Gauss]	130 [1300]	55 [550]
Coercive Strength	Hc	A/m [Oe]	32 [0.4]	9 [0.1]
Less Factor @ Frequency -	tanδ/µi	10-6	500	6
Loss Factor @ Frequency	f	MHz	O.1	0.1
Curie Temperature	Тс	°C	> 140	> 200
Resistivity	ρ	Ω-cm	105	5x10 ²



Ferrite Toroid and Balun Cores

Laird's extensive line of transformer and filter cores are primarily found in most Ethernet (10/100/1000/10G Base-T) and telecom applications. Available in a wide range of sizes, these toroid cores are also designed to carry DC bias of up to 8 mA for traditional Ethernet applications and up to 32 mA for PoE+ applications. They are also available for an extensive temperature (-40 to +85° C) range.



BENEFITS TO CUSTOMER

Broad band noise filtering Higher current handling

ТҮГ	TYPICAL VALUES			COMMON MODE MATERIALS					HIGH PERMEABILITY FOR TELECOM & LOW FREQUENCY FILTERING	LOW POWER LOSS MATERIALS	OTHER MATERIALS
PARAMETER	SYMBOL	UNIT	35 LOW FREQ	28 MID FREQ	25 HIGH FREQ	36 DC BIAS STD TEMP	46 DC BIAS EXTENDED TEMP	66 HIGH DC BIAS EXTENDED TEMP FOR POE & POE+	40	65	35
Relative Initial Permeability	μί		5000	850	125	4500	4000	3200	10000	3300	5000
AL Tolerance		%	± 20	± 20	± 30	± 25	± 25	± 25	± 30	± 25	± 20
Saturation	Bs	Gauss	4500	3250	3600	4500	4500		3800	5300	4500
Flux Density	05	т	450	325	360	450	450	480	380	530	450
at Field	Н	Oersteds	10	10	10	10	10		10	10	10
Intensity		A/m	800	800	800	800	800		800	800	800
Residual	Br	Gauss	1000	2000	2600	1000	1000		1400	800	1000
Flux Density	5.	тт	100	200	260	100	100	130	140	80	100
Coercive	Hc	Oersteds	0.10	0.40	1.60	0.10	0.10		0.04	0.11	0.10
Force		A/m	8	3	127	8	8	10	3	9	8
Relative Loss Factor at	Tanō∕µi	10 ⁶	20	91	740	10	10		5		20
Frequency	f	MHz	0.10	0.10	0.10	0.10	0.10		0.10		0.10
Curie Temperature	Тс	°C	> 150	> 175	> 225	> 150	> 150	> 200	> 120	> 220	> 150
Resistivity	ρ	Ω-cm	10 ²	105	10 ⁶	10 ²	10 ²		1	6.5	10 ²
Density		g/cm³	4.8	4.9	4.9	4.8	4.8	4.9	4.8	4.8	4.8

Extensive Selection of Sizes, Shapes and Impedance Values High Performance, Small Size, Low Cost



Ferrite Rods

28M Series

Features:

- Standard 28mat optimized for superior EMI suppression
- Precise dimension control and automotive grade available
- -40°C to 85°C operating temperature
- Available in wide range of size selection, custom materials or shapes are also available upon request

BENEFITS TO CUSTOMER

Enable lighter and smaller designs Broadband noise filtering

PROPERTY	SYMBOL	UNIT	28 MATERIAL (WPC LISTED)
Initial Permeability	μί		650
Flux Density	В	mT [Gauss]	280 [2800]
@ Field Strength	Н	A/m [Oe]	800 [10]
Residual Field Strength	Br	mT [Gauss]	130 [1300]
Coercive Strength	Hc	A/m [Oe]	32 [0.4]
	tanδ/µi	10 ⁻⁶	500
Loss Factor @ Frequency	f	MHz	[0.1]
Curie Temperature	Тс	°C	> 140
Resistivity	ρ	Ω-cm	10 ⁵



Ferrite Chip Beads

Features:

- Up to 10 A (I MAX) continuous operation capability
- Monolithic construction, high reliability
- Broadband, low frequency and high frequency available.
- For power lines, general signal lines and high-speed signal lines

BENEFITS TO CUSTOMER

High operating current, enable higher power design

Superior performance for broadband noise absorption

ТҮРЕ	EIA PKG. SIZE	METRIC PKG. SIZE	IMPEDANCE @ 100 MHz	RATED CURRENT
Monolithic	0201 - 1806	0603 - 4516	11 - 3000	3200 mA - 6 A
Monolithic	1612 - 3312	4131 - 8531	56 - 800	6 A - 10 A

Ferrite Sheets

MHLL/MSLL/MULL Series

Features:

- Flexible ferrite sheets for 13.56 MHz NFC, RFID application & wireless charging application
- Made by thin, high permeability sintered ferrite with PET film and adhesive tape
- Standard ferrite layer thickness 0.05mm, 0.1mm. 0.2mm & 0.3mm
- Custom size or thickness available upon request
- Operating temperature -40°C to +85°C

BENEFITS TO CUSTOMER

Flexible, easy to install Super thin, save space Lower loss, enabling better read distance

SHAPE	A mm (INCHES)	B mm (INCHES)	C mm (INCHES)	D mm (INCHES)
Cover Tape Cover Tape Ferrite Adhesive	Up to 120 (4.724)	Up to 60 (2.362)	0.05 - 0.30	0.09 - 0.35 (0.004 - 0.014)





Material Specifications for Wireless Charging of RFID Application

PROPERTY	MHLL/MSLL/MULL SERIES
Real Permeability, µ' @ 13.56MHz, 0.1V	130 ± 20% / 100 ± 20% / 150 ± 20%
Imaginary Permeability, µ" @ 13.56MHz, 0.1V	5 max
Operating Temperature, °C	-40°C - +85°C



High Speed Serial Interface Common Mode Chokes

CM0805/1206, CF0504/0805 Series

Features:

- For USB, HDMI, 1394, DVI, S-ATA, LVDS applications
- Both surface mount monolithic and wire wound types are available



BENEFITS TO CUSTOMER

Broadband noise filtering Easy to install and reduce assembly fail

ТҮРЕ	EIA PKG. SIZE	METRIC PKG. SIZE	IMPEDANCE @ 100 MHz (Ω)	RATED CURRENT
Monolithic	0504 - 0805	1008 - 2012	67 - 220	300 mA - 400 mA
Wire Wound	0805 - 1206	2012 - 3216	90 - 600	100 mA - 400 mA

Power Line Common Mode Chokes (Arrays)

Thru-Hole and Surface Mount Type

Features:

- Up to 75 Amp
- For servers, workstations, power adapter, medical equipment, automotive, industrial etc.



BENEFITS TO CUSTOMER

Enable higher power designs

Easy to install and reduce assembly fail

Reduce total EMC cost

ТҮРЕ	EIA PKG. SIZE	METRIC PKG. SIZE LxW mm	IMPEDANCE @ 100 MHz	RATED CURRENT
Surface Mount	2021 - 2824	5 x 5.6 - 75 x 55	33 - 3500	800 mA - 15 A
Thru-Hole	2545 - 5740	6.3 x 11.3 - 14.4 x 10	100 - 800	200 mA - 75 A

Wire-Wound SMT Power Common Mode Chokes for Broad Band Frequency

CM7060 Series

Features:

- Common mode filter for large current up to 9A
- Excellent common mode impedance and noise suppression
- Compact size
- Operating temperature -40°C to 125°C (including self-heating)
- AEC-Q200 qualified



BENEFITS TO CUSTOMER

Enable higher power designs Easy to install and reduce assembly fail Reduce total EMC cost

	SIZE MAX (mm)	IMPEDANCE Z @	INSULATION	DCR 1	RATING	RATING
	(LxWxH)	100 MHz (Ω)	RESISTANCE MIN (MΩ)	LINE (Ω)	CURRENT (A)	VOLTAGE (V)
Wire Wound SMD	7.7 x 6.5 x 3.8	140 - 1300	10.0	0.01 - 0.025	2.5 - 9.0	80



Wire-Wound SMT Power Common Mode Chokes for Low Frequency

CMX1211 Series

Features:

- Small size with high current
- SMT type with less height
- Stable performance under load bias and high reliability
- High suppression of asymmetric interferences at both low and high frequencies

BENEFITS TO CUSTOMER

Enables higher power designs Reduces total EMC cost

ТҮРЕ	SIZE MAX (mm) (LxWxH)	INDUCTANCE @100 KHz/Mv (µH)	DCR MAX (mΩ)	CURRENT RATING MAX (A)	RATING VOLTAGE MAX (Vrms)	HIPOT COIL (VAC)
Wire Wound SMD	31.5 x 28.8 x 19	68 - 1800	0.56 - 14.00	9 - 50	250	1500

Wire-Wound DIP Power Common Mode Chokes for Low Frequency

CMX1616 Series

Features:

- Current rating up to 62 Amp
- Stable performance and high reliability
- High suppression of asymmetric interferences at both low and high frequency
- Operation temperature: -40°C to 125°C (including self-heating)
- Custom designs on request



BENEFITS TO CUSTOMER

Enables higher power designs Reduces total EMC cost

ТҮРЕ	SIZE MAX (mm) (LxWxH)	INDUCTANCE @ 100 KHz/mV (µH)	DCR MAX (mΩ)	CURRENT RATING MAX (A)	RATING VOLTAGE MAX (Vrms)	HIPOT COIL (VAC)
Wire Wound DIP	42.0 x 41.0 x 16.5	704 - 2816	0.65 - 11.0	14 - 62	250	1500

High Current Power Line Common Mode Chokes

CM8663 Series

Features:

- Common mode choke for high current up to 65Adc
- Excellent common mode impedance and noise suppression
- Compact size & robust construction
- Operating temperature -40°C to 155°C (including self-heating)
- Through hole installation
- Very low DCR



BENEFITS TO CUSTOMER

Enables higher power designs

High reliability with high insulation

Saves board layout space Reduces total EMC cost

	TYPICAL IMPEDANCE (Ω)			2)				
SIZE MAX (mm) (LxWxH)	Z @ 25 MHz	Z @100 MHz	<u> </u>		TYPICAL PEAK IMPEDANCE (Ω)	TYPICAL PEAK IMPEDANCE FREQUENCY (MHz)	DCR MAX (mΩ)	RATED CURRENT
22.40 x 16.30 x 16.75	85	160	210	140	300	340	0.15	65Adc



Steward™

Axial Lead Ferrite Bead / Ferrite Differential Mode Array

Features:

- Differential mode EMI filter, high current, thru-hole/surface mount type
- Up to 10 amps continuous operation
- For power line application for LCD-TV, automotive, industrial, medical, audio equipment.



BENEFITS TO CUSTOMER

Easy to install and reduce assembly fail Reduce total EMC cost

ТҮРЕ	IMPEDANCE @ 100 MHz (Ω)	RATED CURRENT
Axial Wire Ferrite Filter		
Wire Leads Thru Ferrite	75 - 220	5 A
Wire Wound Thru Ferrite	460 - 990	5 A
Differential Mode EMI Filter Array		
Thru-Hole / Surface Mount	75 - 342	6 A - 10 A

SMT Ferrite Bead Assembly

Features:

- 10 Amps continuous operating current capability
- Very low DCR
- Broadband (28F) and (35F) parts available
- Lead free and RoHS compliant



BENEFITS TO CUSTOMER

Enable higher power designs High reliability Easy to install and reduce assembly fail Reduce total EMC cost

ТҮРЕ	IMPEDANCE @ 100 MHz (Ω)	RATED CURRENT
SMT Ferrite Filter		
Wire Leads Thru Ferrite	41 - 115	10 A

Ferrite Bead for Automotive

Part Number 38F0126-0SR-1XXXX Custom Part Number

(A specific P/N suffix will be assigned upon request for particular customer)

Features:

- EMI filtering for High speed CAN-BUS in automotive
- Wire inserted bead enable highly automatic process
- Surface mount device
- Robust ferrite construction, high reliability and AECQ200 compliant

BENEFITS TO CUSTOMER

High reliability

Easy to install and reduce assembly fail

Reduce total EMC cost

12 | MAGNETIC CERAMIC PRODUCTS

Multilayer Inductors for General Circuits

IC0603/0805/1206 Series

Features:

- Monolithic construction. high reliability
- Broadband and high frequency available
- For RF and wireless communication. computers, telecommunications, automotive electronics etc.

BENEFITS TO CUSTOMER

Broadband filtering Easy to install and reduce assembly fail

Reduce total EMC cost

ТҮРЕ	EIA PKG. SIZE	METRIC PKG. SIZE	L (nH)	SRF	RATED CURRENT
Monolithic	0603 - 1206	1608 - 3216	47 - 33,000	313 MHz - 320 MHz	5 mA - 300 mA

Multilayer Power Inductors

CPI0805/0806/1008 Series

Features:

- Small size (EIA 0805, 0806 and 1008) with max 1.0 mm in thickness
- Stable low DC resistance performance in the class
- Lead-free product and support lead-free soldering

BENEFITS TO CUSTOMER

Enable higher power designs e

BENEFITS TO CUSTOMER

Enable higher power

Robust construction

and high reliability

designs

ТҮРЕ	EIA PKG. SIZE	METRIC PKG. SIZE	INDUCTANCE (µH)	INDUCTANCE TOLERANCE	TEST FREQ (MHz)	DCR TYPICAL (Ω)	RATED CURRENT
	0805	2012	0.47 - 4.7	± 20%	1	0.10 - 0.30	500 mA - 1100 mA
Monolithic (Ferrite)	0806	2016	0.47 - 4.7	± 20%	1	0.14 - 0.30	1100 mA - 1500 mA
(i cirito)	1008	2520	0.47 - 4.7	± 20%	1	0.07 - 0.20	1100 mA - 1800 mA

Ferrite Rod Inductors

1XC Series

Features:

- Extremely low DC and AC resistance
- Multiple sizes offered
- Current up to 19A
- Operating temp up to 150°C

SIZE MAX (mm) (LxWxH)	INDUCTANCE (μ H) L $@$ 10KHz/0.1v ± 25%	DCR (Ω)	RATING CURRENT (A)	
30.30 x 10.15 x 9.0	1 - 15	0.003 - 0.024	2.4 - 19.0	



Easy to install and reduc assembly fail
Reduce total EMC cost





IP Series Power Inductors

Features:

- Ferrite shielded or unshielded structure
- Low DCR and high efficiency
- Low profile and small size
- Wide range of inductance selection up to mH •







IPSH





IPSD

IPSE

IPUD

	INDUCTANCE	CURRENT
SERIES	RANGE (µH)	RANGE (A)
IPSD		
IPSD63	10 - 100	0.330 - 1.00
IPSD74	10 - 220	0.360 - 1.65
IPSD105	10 - 470	0.330 - 2.06
IPSD1608	1 - 10000	0.02 - 3
IPSD3316	1 - 47	1 - 5.6
IPSD5022	10 - 1000	0.8 - 8
IPSF		
IPSF625	4.7 - 100	0.33 - 1.5
IPSF628	4.7 - 100	0.42 - 1.6
IPSF728	3.3 - 47	0.54 - 1.6
IPSF732	3.3 - 1000	0.13 - 1.9
IPSF745	3.3 - 1000	0.14 - 2.5
IPSF1045	3.3 - 1500	0.22 - 4.9
IPSF1255	6 - 1500	0.29 - 3.6
IPSF1265	2 - 220	1 - 10
IPSF1275	1.2 - 220	1.3 - 13
IPSH		
IPSH2D18	2.2 - 33	0.23 - 0.85
IPSH3D16	1.5 - 33	0.32 - 1.55
IPSH4D18	1 - 180	0.14 - 1.72
IPSH4D28	1.2 - 390	0.13 - 2.56
IPSH5D18	4.1 - 330	0.18 - 1.95

BENEFITS TO CUSTOMER

Enable lighter and smaller designs

Easy to install and reduce assembly fail

INDUCTANCE CURRENT RANGE (A) SERIES RANGE (µH) IPSD 10 - 390 0.115 - 0.76 IPUD32 IPUD42 1 - 82 0.36 - 2.70 IPUD43 1 - 470 0.21 - 3.80 IPUD52 1.2 - 470 0.15 - 4.20 IPUD53 1 - 1000 0.13 - 4.50 IPUD54 1 - 1000 0.14 - 5.90 IPUD73 10 - 330 0.28 - 1.44 IPUD75 10 - 470 0.34 - 2.30 IPUD104 10 - 560 0.32 - 2.38 IPUD105 10 - 820 0.24 - 2.60 IPUD1608 1 - 1000 0.1 - 2.9 IPUD1813 0.56 - 47 0.87 - 7.7 IPUD3308 10 - 1000 0.1 - 2.4 IPUD3316 1 - 1000 0.3 - 9 IPUD3316H 0.33 - 4.7 5.4 - 20 IPUD3340 10 - 1000 0.8 - 8 IPUD5022 1 - 1000 1 - 20 IPUD5022H 0.78 - 15 8 - 30



TYS Low Profile SMT Power Inductors

Features:

- Magnetic resin shield structure
- Low DCR and high efficiency
- Low profile and small size
- High reliability



BENEFITS TO CUSTOMER

Enable lower profile and more compact designs

Easy to install and reduce assembly fail

Self-shielded and reduce EMC cost

SERIES	SIZE (A*B*C) mm	INDUCTANCE (µH)	DCR TYP. OHM	ISAT TYP. A	IRMS TYP. A	SRF MHz
TYS3010	3.0 x 3.0 x 1.0	1.0 - 47	0.0850 - 0.2535	0.22 - 1.40	0.26 - 1.45	18 - 180
TYS3012	3.0 x 3.0 x 1.2	1.0 - 100	0.0520 - 3.7180	0.21 - 1.87	0.25 - 2.20	12 - 120
TYS3015	3.0 x 3.0 x 1.5	1.0 - 47	0.0450 - 1.6250	0.35 - 2.32	0.35 - 2.35	14 - 150
TYS4012	4.0 x 4.0 x 1.2	1.0 - 100	0.0650 - 2.8730	0.25 - 2.61	0.25 - 1.65	9.4 - 120
TYS4018	4.0 × 4.0 × 1.8	1.0 - 220	0.0325 - 5.2000	0.27 - 4.80	0.17 - 2.00	4 - 80
TYS4020	4.0 × 4.0 × 2.0	1.0 - 100	0.0377 - 2.8370	0.25 - 4.78	0.25 - 2.15	9.4 - 75
TYS4030	4.0 × 4.0 × 3.0	1.0 - 120	0.0182 - 1.7550	0.55 - 5.26	0.42 - 4.15	5.4 - 70
TYS5020	5.0 x 5.0 x 2.0	1.0 - 22	0.0260 - 0.2940	1.15 - 4.10	1.10 - 3.80	14 - 114
TYS5040	5.0 x 5.0 x 4.0	1.0 - 100	0.0144 - 0.6720	0.75 - 7.35	0.70 - 4.90	4.7 - 117
TYS6020	6.0 x 6.0 x 2.0	1.0 - 22	0.0260 - 0.2652	1.05 - 4.15	1.00 - 3.50	16 - 100
TYS6028	6.0 x 6.0 x 2.8	1.0 - 100	0.0130 - 0.6500	0.65 - 5.75	0.70 - 5.20	7.1 - 70
TYS6045	6.0 × 6.0 × 4.5	1.0 - 330	0.0143 - 1.6510	0.57 - 9.85	0.57 - 5.14	2.8 - 100
TYS8040	8.0 x 8.0 x 4.0	1.0 - 330	0.0104 - 1.1557	0.68 - 9.85	0.64 - 6.30	2.8 - 89



MGV High Current Molded SMT Power Inductors

Features:

- Magnetic resin shield structure
- Low DCR and high efficiency
- Low profile and small size
- High reliability
- AEC-Q200 qualified



BENEFITS TO CUSTOMER

- Enable higher power designs
- Easy to install and reduce assembly fail
- High reliability
- Self-shielded and reduce EMC cost

SERIES	SIZE (A*B*C) mm	INDUCTANCE (µH)	DCR (mΩ) MAX	ISAT (A) MAX	IRMS (A) MAX
MGV0412	4.5 x 4.1 x 1.0	0.1 - 22.0	5.5 - 1050	1.0 - 25.0	0.8 - 11.5
MGV0402	4.5 x 4.1 x 2.0	0.1 - 22.0	4.0 - 500	1.4 - 35.0	1.2 - 12.0
MGV0512	57 x 5.2 x 1.0	0.1 - 15.0	5.2 - 470	1.6 - 14.5	1.3 - 14.0
MGV0502	5.5 x 5.1 x 2.0	0.1 - 10.0	4.0 - 199	3.4 - 45.0	2.3 - 18.0
MGV0503	5.5 x 5.1 x 3.0	0.1 - 33.0	3.0 - 440	1.6 - 27.0	1.6 - 23.0
MGV0602	7.2 x 6.7 x 2.0	0.1 - 22.0	2.4 - 280	2.5 - 40.0	1.5 - 21.0
MGV0625	7.2 × 6.7 × 2.4	0.1 - 22.0	1.7 - 215	3.0 - 70.0	1.8 - 30.0
MGV0603	7.2 x 6.7 x 3.0	0.1 - 47.0	1.7 - 363	2.0 - 60.0	1.8 - 32.5
MGV0605	7.2 x 6.7 x 5.0	0.22 - 47.0	1.9 - 330	2.7 - 35.0	1.9 - 25.0
MGV1004	11.0 x 10.0 x 3.8	0.15 - 47.0	0.6 - 167	4.5 - 75.0	3.0 - 43.0
MGV1205	13.5 x 12.6 x 5.0	0.22 - 33.0	0.7 - 88.0	8.0 - 110.0	5.0 - 52.0
MGV1207	13.5 x 12.6 x 6.2	0.15 - 47.0	0.6 - 90.0	6.5 - 60.0	6.5 - 55.0

WIRELESS CHARGING COIL ASSEMBLY

WPC Wireless Charging Coil Assembly

Features:

- Designed to meet WPC Qi standard, custom designs available upon request, Automotive grade available upon request
- Operating temperature -40°C to + 85°C
- Assembled with ferrite plate which is built with WPC listed ferrite material, high Q for maximum power transmission
- Integrated module available with pin connector and plastic frame for easy installation



BENEFITS TO CUSTOMER

Qi compliant

Easy to install and reduce assembly fail

Enable fast charging and minimize charging blind spots

			SIZE	IND	UCTANCE	E (µH ± 10	%)		Q @
PRODUCT IMAGE	ТҮРЕ	P/N	(mm)	COIL	MIN	NOM	мах	DCR MAX (mΩ)	100 KHz/1v (MIN)
	A1 Coil	RWC5353EJ240-500 RWC5353EJ240-501	53.0 x 53.0 x 6.7	-	21.60	24.00	26.40	75	90
	A6 Single Coil	SWC5547AK120-500	55.2x47.2x3.0	-	11.25	12.50	13.75	65	90
(1)	A6 Multiple	SWC10056AA120-500		Bottom	11.25	12.50	13.75	65	90
	Coil			Тор	10.35	11.50	12.65		
	A11 Coil	RWC5050AK060-500	Ψ50.0 x 3	-	5.85	6.5	7.15	50	70
	RX Coil	SWC4242KB120-100	38.0 x 38.0 x 0.7	-	11.25	12.5	13.75	240	20
	15 Watt Coil	SWC4848KA100-600	48.5 x 48.5 x 1.0	-	9.00	10.00	11.00	180	Rated Current 2A
	Litz coil and 3D shaped ferrite module	RWC2727AH070-300	49.36 x 27.0 x 4.2	-	5.00	5.50	6.00	48.3	-
	TX coil	Available upon	99x59x4.4	Bottom	11.25	12.50	13.75	65	90
		request		Тор	10.35	11.50	12.65		

MEMO





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